

## PATENT ASSIGNMENT COVER SHEET

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<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
BIN WANG	08/20/2015
JIAN CEN	06/04/2015
PENG ZHANG	06/04/2015
FANG LIU	06/04/2015
HUI YU	06/04/2015
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<b>City:</b>	SHENZHEN
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<b>Postal Code:</b>	518057
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
Application Number:	14649874
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<b>ATTORNEY DOCKET NUMBER:</b>	38739/347
<b>NAME OF SUBMITTER:</b>	KORY D. CHRISTENSEN
<b>SIGNATURE:</b>	/Kory D. Christensen/
<b>DATE SIGNED:</b>	09/18/2015

**Total Attachments: 3**

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PATENT APPLICATION  
Docket No.: 38739/347  
Mindray Ref: IP347-1510MR-US

ASSIGNMENT

We, Bin WANG, Jian CEN, Peng ZHANG, Fang LIU, and Hui YU, have invented the inventions described in a United States Patent Application Serial No. 14/649,874, DEVICE FOR MEASURING MUSCLE RELAXATION AND MONITORING EQUIPMENT, filed on June 4, 2015, in the United States Patent and Trademark Office.

The Assignee, Shenzhen Mindray Bio-Medical Electronics Co., Ltd., a corporation of P.R. China, having a principal place of business at Mindray Building, Keji 12th Road South, Hi-tech Industrial Park, Nanshan, Shenzhen, P.R. China 518057, desires to secure the entire right, title and interest therein.

For good and valuable consideration, the receipt and sufficiency of which we hereby acknowledge, WE HEREBY ASSIGN TO THE ASSIGNEE:

The entire right, title, and interest in the above-identified United States patent application and in all patents issuing thereon, any inventions described in said application, and in all divisions, continuations, continuations-in-part, reissues, or extensions of said application, and in all corresponding applications filed in countries foreign to the United States and all foreign patents issuing thereon.

The right to file foreign patent applications on said invention in its own name, wherever such right may be legally exercised, including the right to claim the benefits of the International Convention for such applications.

We hereby authorize and request the United States Commissioner of Patents and Trademarks, and such Patent Office officials in foreign countries as are duly authorized by their patent laws to issue patents, to issue any and all patents on said invention to the Assignee as the owner of the entire interest, for the sole use and benefit of the said Assignee, its successors, assigns and legal representatives.

We hereby agree, without further consideration and without expense to us, to sign all lawful papers and to perform all other lawful acts which the Assignee may request of us to make this Assignment fully effective, including, by way of example but not of limitation, the following:

Prompt execution of all original, divisional, substitute, reissue, and other United States and foreign patent applications on said invention, and all lawful documents requested by the Assignee to further the prosecution of any of such patent applications.

Cooperation to the best of my ability in the execution of all lawful documents, the production of evidence, nullification, reissue, extension, or infringement proceedings involving said invention.

This assignment and agreement shall be binding upon our heirs and legal representatives.

Bin WANG  
Bin WANG

2015-8-20  
DATE (YYYY-MM-DD)

Jian CEN  
Jian CEN  
DATE (YYYY-MM-DD)

2015.6.4  
Peng ZHANG

Peng ZHANG 2015-06-04  
DATE (YYYY-MM-DD)

Fang LIU  
Fang LIU

2015-06-04  
DATE (YYYY-MM-DD)

Hui Yu

Hui YU

2015-06-04

DATE (YYYY-MM-DD)